

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Akihiko KANDA	03/16/2009
RECEIVING PARTY DATA	
Name:	RENESAS TECHNOLOGY CORP.
Street Address:	6-2, Otemachi 2-chome, Chiyoda-ku,
City:	Tokyo
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12436611
CORRESPONDENCE DATA	
<p>Fax Number: (202)756-8087</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 202-756-8000</p> <p>Email: Kadkins@mwe.com</p> <p>Correspondent Name: McDermott Will & Emery LLP</p> <p>Address Line 1: 600 Thirteenth Street, N.W.</p> <p>Address Line 4: Washington, DISTRICT OF COLUMBIA 20005-3096</p>	
ATTORNEY DOCKET NUMBER:	067237-0539
NAME OF SUBMITTER:	Bernard P. Codd
<p>Total Attachments: 2</p> <p>source=0672370539assignmenttransmittal#page1.tif</p> <p>source=0672370539assignment#page1.tif</p>	

CH \$40.00 12436611

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PATENT
REEL: 022648 FRAME: 0451

RECORDATION FORM COVER SHEET

Docket No.: 067237-0539

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

Akihiko KANDA

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): **March 16, 2009**

- ☒ **Assignment** ☐ **Merger**
☐ **Security Agreement** ☐ **Change of Name**
☐ **Joint Research Agreement**
☐ **Government Interest Assignment**
☐ **Executive Order 9424, Confirmatory License**
☐ **Other**

2. Name and address of receiving party(ies)

Name: **RENESAS TECHNOLOGY CORP.**

Internal Address:

Address: **6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo, JAPAN**

Additional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application or patent number(s):

A. Patent Application No(s).

☒ This document is being filed together with a new application.

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: **MCDERMOTT WILL & EMERY LLP**

Internal Address:

Street Address: **600 13th Street, N.W.**

City: **Washington** State: **D. C.** Zip: **20005-3096**

Phone Number: **202.756.8000**

Fax Number: **202.756.8087**

Email Address:

6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☐ Authorized to be charged by credit card
☒ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information:

- a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number **500417**
Authorized User Name _____

9. Signature.

Stephen A. Becker 26,527

Bernard P. Cobb (Reg. No. 46,429) for

May 6, 2009

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: **2**

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan, located at 6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR MEMORY DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Technology Corp., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Akihiko KANDA</u>	<u>Akihiko KANDA</u>	<u>16 / March / 2009</u>
2) _____	_____	_____
3) _____	_____	_____
4) _____	_____	_____
5) _____	_____	_____
6) _____	_____	_____
7) _____	_____	_____
8) _____	_____	_____
9) _____	_____	_____
10) _____	_____	_____